

FDD5810

N-Channel Logic Level Trench[®] MOSFET 60V, 36A, 27m Ω

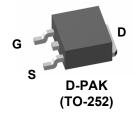
Features

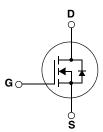
- $R_{DS(ON)} = 22m\Omega$ (Typ.), $V_{GS} = 5V$, $I_D = 29A$
- $Q_{q(5)} = 13nC$ (Typ.), $V_{GS} = 5V$
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse / Repetitive Pulse)
- Qualified to AEC Q101
- RoHS Compliant

Applications

- Motor / Body Load Control
- ABS Systems
- Powertrain Management
- Injection System
- DC-DC converters and Off-line UPS
- Distributed Power Architecture and VRMs
- Primary Switch for 12V and 24V systems







Absolute Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain to Source Voltage	60	V
V _{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (V _{GS} = 10V)	37	Α
	Drain Current Continuous (V _{GS} = 5V)	33	Α
'D	Continuous ($T_A = 25^{\circ}\text{C}$, $V_{GS} = 10\text{V}$, with $R_{\theta JA} = 52^{\circ}\text{C/W}$)	7.4	Α
	Pulsed	Figure 4	Α
E _{AS}	Single Pulse Avalanche Energy (Note 1)	45	mJ
	Power Dissipation	72	W
P_{D}	Derate above 25°C	0.48	W/°C
T _J , T _{STG}	Operating and Storage Temperature	-55 to 175	°C

Thermal Characteristics

$R_{\theta JC}$	Maximum Thermal resistance Junction to Case TO-252	2.1	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-252, 1in ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD5810	FDD5810	TO-252AA	A 330mm 16		2500 units

Electrical Characteristics $T_J = 25$ °C unless otherwise noted

Symbol	Parameter	Test Cor	nditions	Min	Тур	Max	Units
Off Chara	octeristics						
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS}$; = 0V	60	-	-	V
I	Zero Gate Voltage Drain Current	$V_{DS} = 48V$		-	-	1	^
IDSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V$	$T_{\rm C} = 150^{\rm o}{\rm C}$	-	-	250	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

On Characteristics

V _{GS(TH)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	1.6	2	V
D	R _{DS(ON)} Drain to Source On Resistance	$I_D = 32A, V_{GS} = 10V$	-	18	22	
		$I_D = 29A, V_{GS} = 5V$	-	22	27	mΩ
US(ON)		$I_D = 32A, V_{GS} = 10V,$ $T_J = 175^{\circ}C$	-	43	53	11122

Dynamic Characteristics

C _{iss}	Input Capacitance	V 05V V 0V	-	1420	1890	pF
C _{oss}	Output Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz	-	150	200	pF
C _{rss}	Reverse Transfer Capacitance	1 - 111112	-	65	100	pF
R _G	Gate Resistance	f = 1MHz	-	3.5	-	Ω
Q_g	Total Gate Charge at 10V	V _{GS} = 0V to 10V	-	24	34	nC
$\frac{Q_g}{Q_{g(th)}}$	Total Gate Charge at 5V	V _{GS} = 0V to 5V	-	13	18	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0V \text{ to } 1V$ $V_{DD} = 30V$ $I_{D} = 35A$	-	1.3	-	nC
Q _{gs}	Gate to Source Gate Charge	ID = 35A	-	4.0	-	nC
Q _{gs} Q _{gs2}	Gate Charge Threshold to Plateau		-	2.7	-	nC
Q _{gd}	Gate to Drain "Miller" Charge]	=	5.0	-	nC

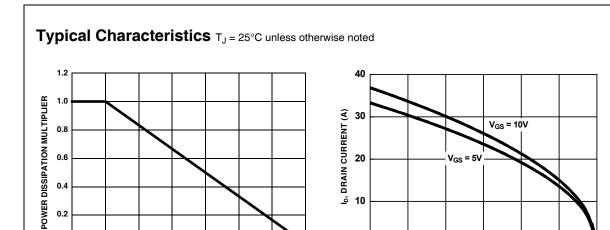
Switching	Charact	teristics
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t _{on}	Turn-On Time		-	-	130	ns
t _{d(on)}	Turn-On Delay Time		-	12	-	ns
t _r	Rise Time	$V_{DD} = 30V, I_D = 35A$	-	75	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 5V$, $R_{GS} = 11\Omega$	-	26	-	ns
t _f	Fall Time		-	34	-	ns
t _{off}	Turn-Off Time		-	-	90	ns

Drain-Source Diode Characteristics

V _{SD} Source to Drain Diode Voltage	Source to Drain Diade Voltage	I _{SD} = 32A	-	-	1.25	V
	I _{SD} = 16A	-	-	1.0	V	
t _{rr}	Reverse Recovery Time	I _F = 35A, di/dt = 100A/μs	-	-	39	ns
Q _{rr}	Reverse Recovery Charge	I _F = 35A, di/dt = 100A/μs	-	-	35	nC

Notes: 1: Starting T_J = 25°C, L = 110 $\mu H,~I_{AS}$ = 28A, V_{DD} = 54V, V_{GS} = 10V.



175

150

Figure 1. Normalized Power Dissipation vs Case Temperature

T_C, CASE TEMPERATURE (°C)

100

0

0

25

Figure 2. Maximum Continuous Drain Current vs Case Temperature

100

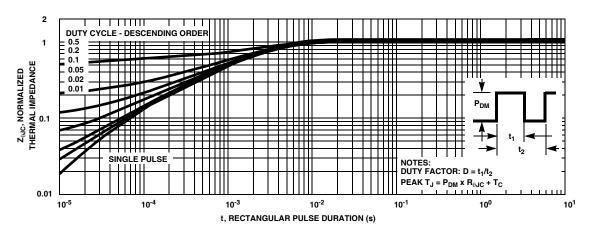
T_C, CASE TEMPERATURE(°C)

125

150

175

75



0

25

50

Figure 3. Normalized Maximum Transient Thermal Impedance

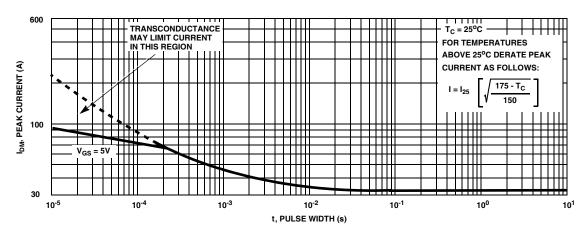
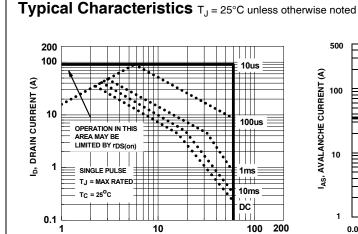


Figure 4. Peak Current Capability



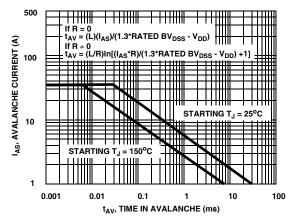


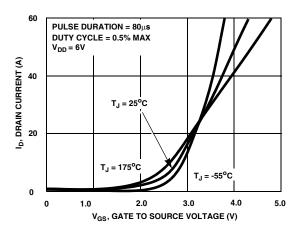
Figure 5. Forward Bias Safe Operating Area

V_{DS}, DRAIN TO SOURCE VOLTAGE (V)

NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability



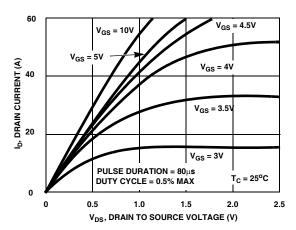
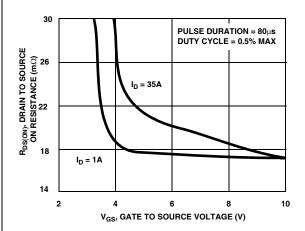


Figure 7. Transfer Characteristics

Figure 8. Saturation Characteristics



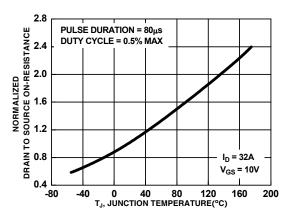


Figure 9. Drain to Source On Resistance vs Gate Voltage and Drain Current

Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics T_J = 25°C unless otherwise noted

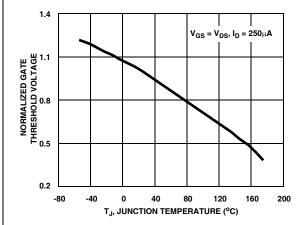


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

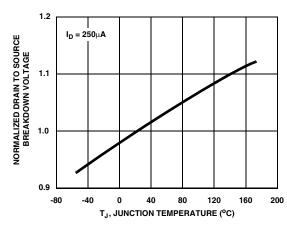


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

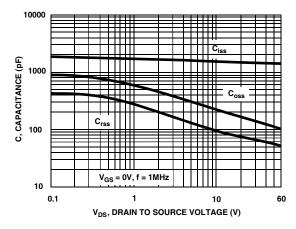


Figure 13. Capacitance vs Drain to Source Voltage

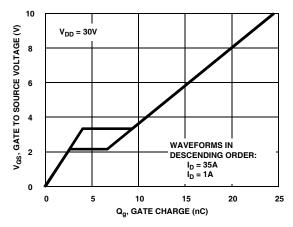


Figure 14. Gate Charge Waveforms for Constant Gate Current





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Rev. I31